

FUJITSU Component Connector

FCN-074B / 078B series

Card Edge Connector for DDR4 Memory Module

RoHS compliant

Overview

This is a 288-pin DIMM socket that conforms to JEDEC standards.

Features

- **Highly reliable contact**
Contact reliability with a module substrate is improved by a Fujitsu proprietary double-contact structure, which is resistant to dust and flux
- **Various terminal shapes to match with substrate design and mounting form**
One surface mount type, one press fit type, and three through-hole types having different terminal lengths are included in this lineup
- **Flame resistant UL94V-0**
Flame resistant UL94V-0 LCP resin is used for the housing insulating material
- **Typical applications**
DRAM-memory module connections for HPCs (servers, supercomputers), communication measurement apparatuses and office equipment



DDR4 DIMM socket

Item	Specification
Operating temperature range	-55°C to +85°C
Max. current rating	0.75A
Max. voltage rating	29VAC
Contact resistance	40mΩ maximum (10mA, 20mVDC)
Insulation resistance	1MΩ minimum (500VDC)
Dielectric withstanding voltage	500VAC for 1 minute
Substrate insertion force	126.4N less than

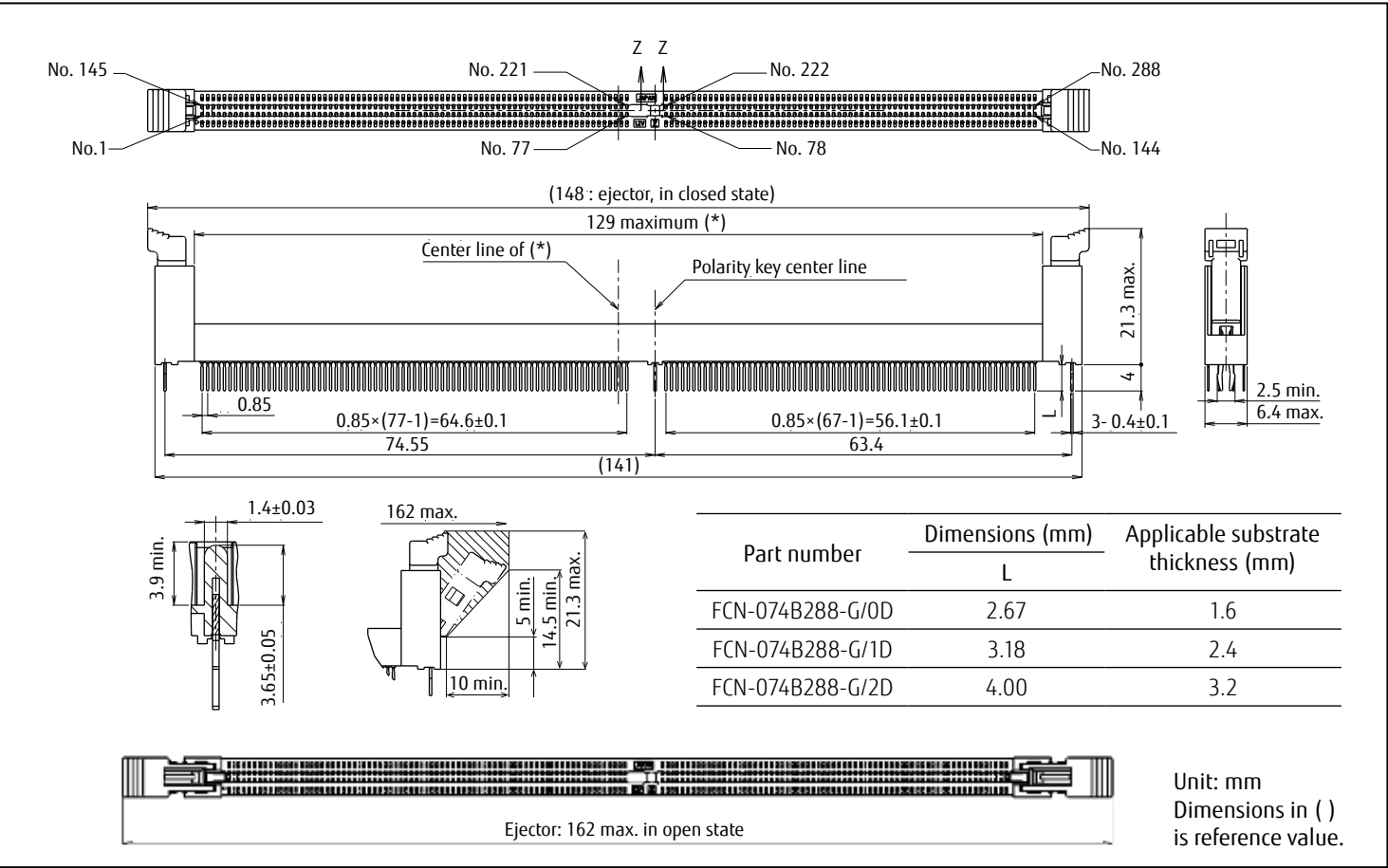
Item	Material, surface treatment	
Insulation material	LCP resing (UL94V-0)	
Conductor	Copper alloy	
Surface treatment	Contact	Gold plating (PAGOS)
	Terminal	Gold coat
Ejector	PA resin (UL94V-0)	
Metal fitting	Copper alloy (tin plating)	

■ Part numbers and dimensions

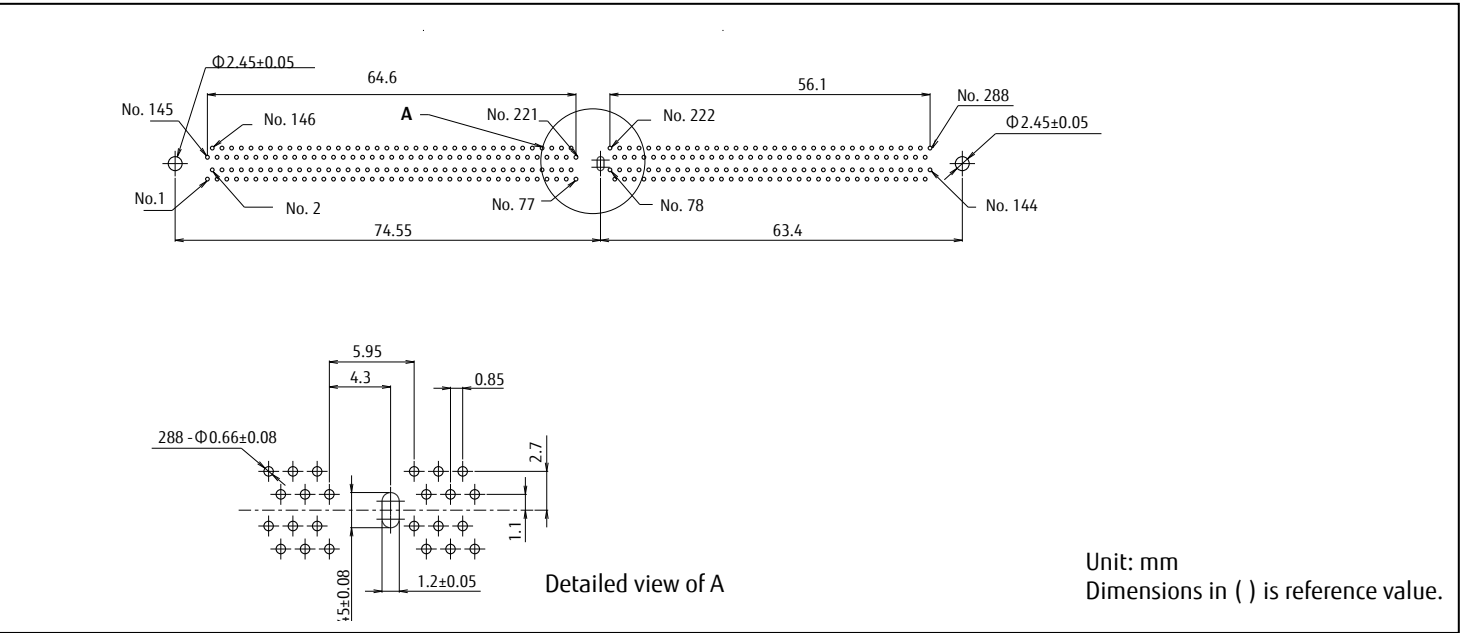
Part number	Terminal shape	Substrate thickness	Number of pins	Package format	Min. package unit	Min. shipment unit
FCN-074B288-G/0D	Through hole	1.6	288	Tray	40 pieces	200 pieces
FCN-074B288-G/1D		2.4	288		40 pieces	200 pieces
FCN-074B288-G/2D		3.2	288		40 pieces	200 pieces
FCN-078B288-G/0	Surface mount	-	288		40 pieces	200 pieces
FCN-074B288-G/0P	Press fit	1.6 min.	288		40 pieces	200 pieces

■ Dimensions

- Through-hole type FCN-074B288-G/□□
Memory module conforms to JEDEC MO-309)

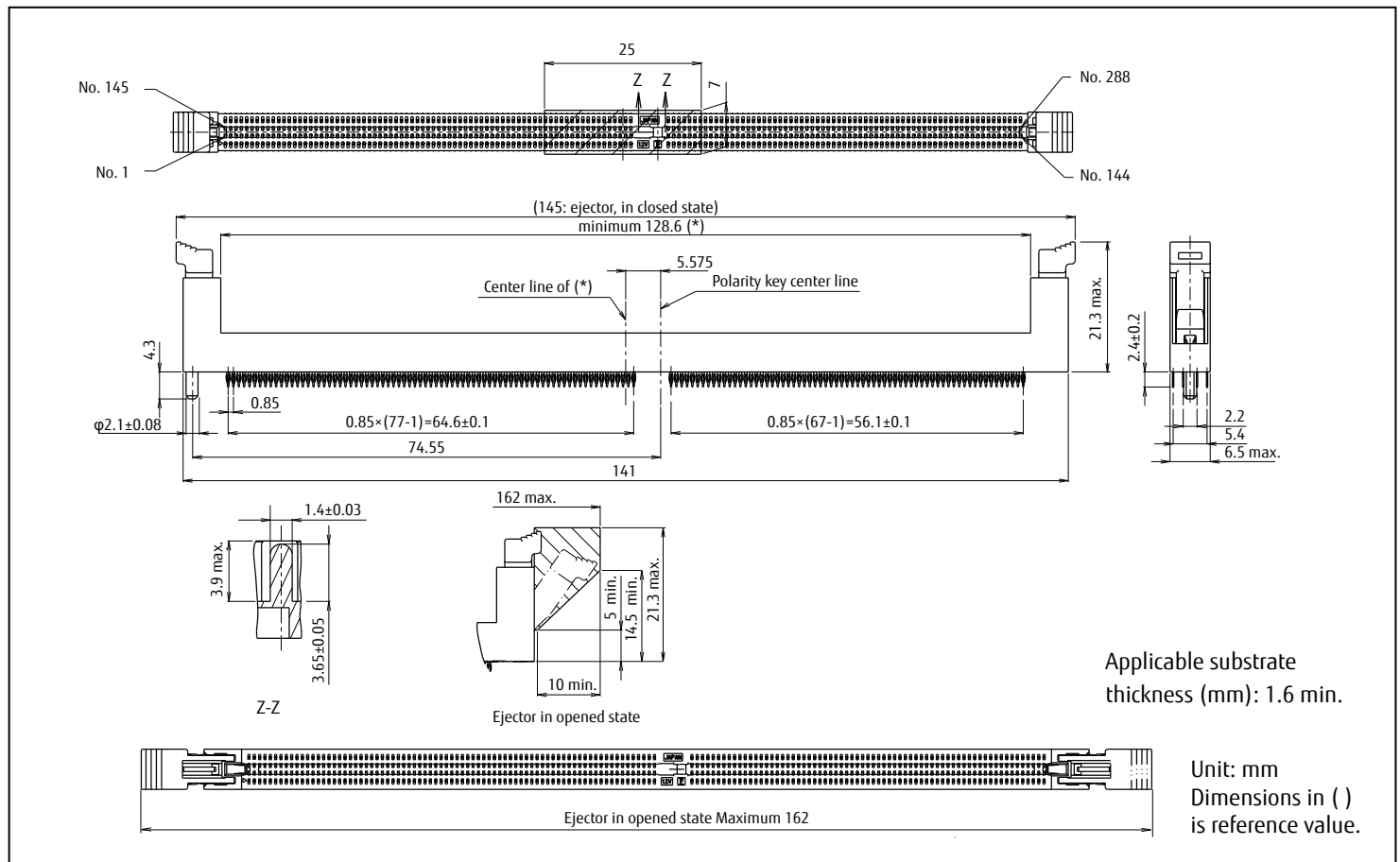


- Recommended printed circuit board (Top view)

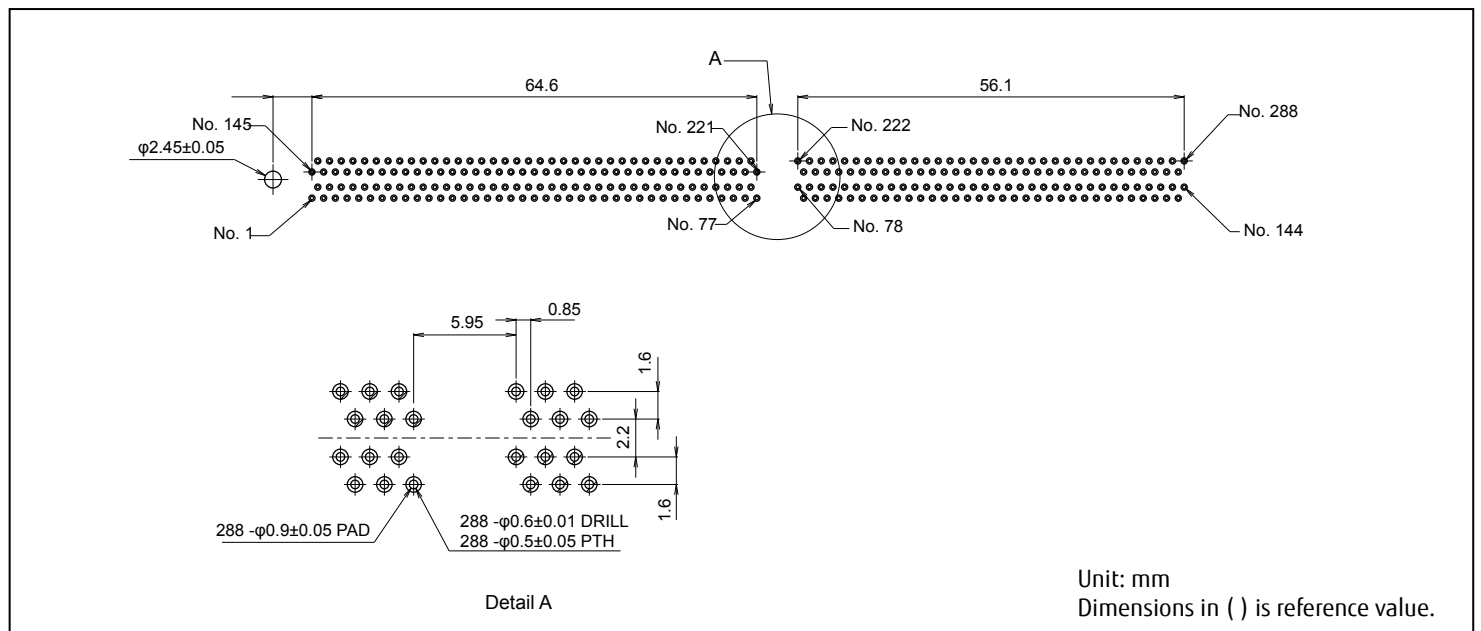


- Dimensions

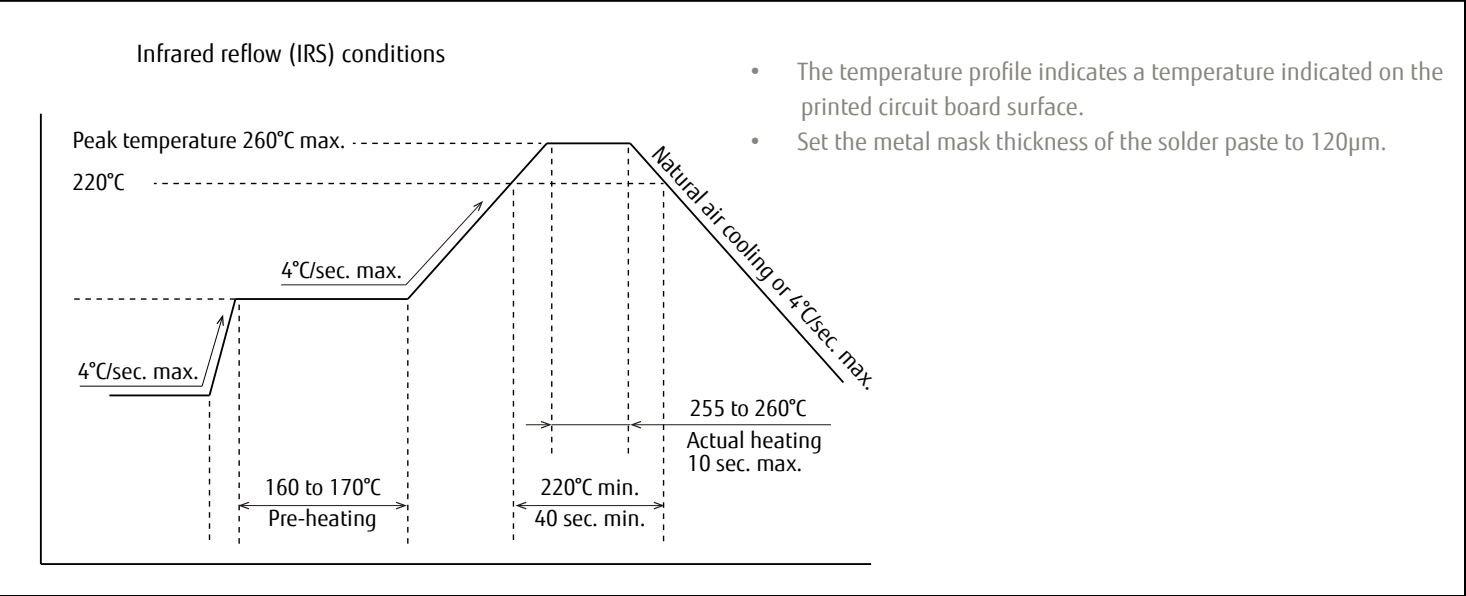
- Press fit type FCN-074B288-G/0P
Memory module conforms to JEDEC MO-309)



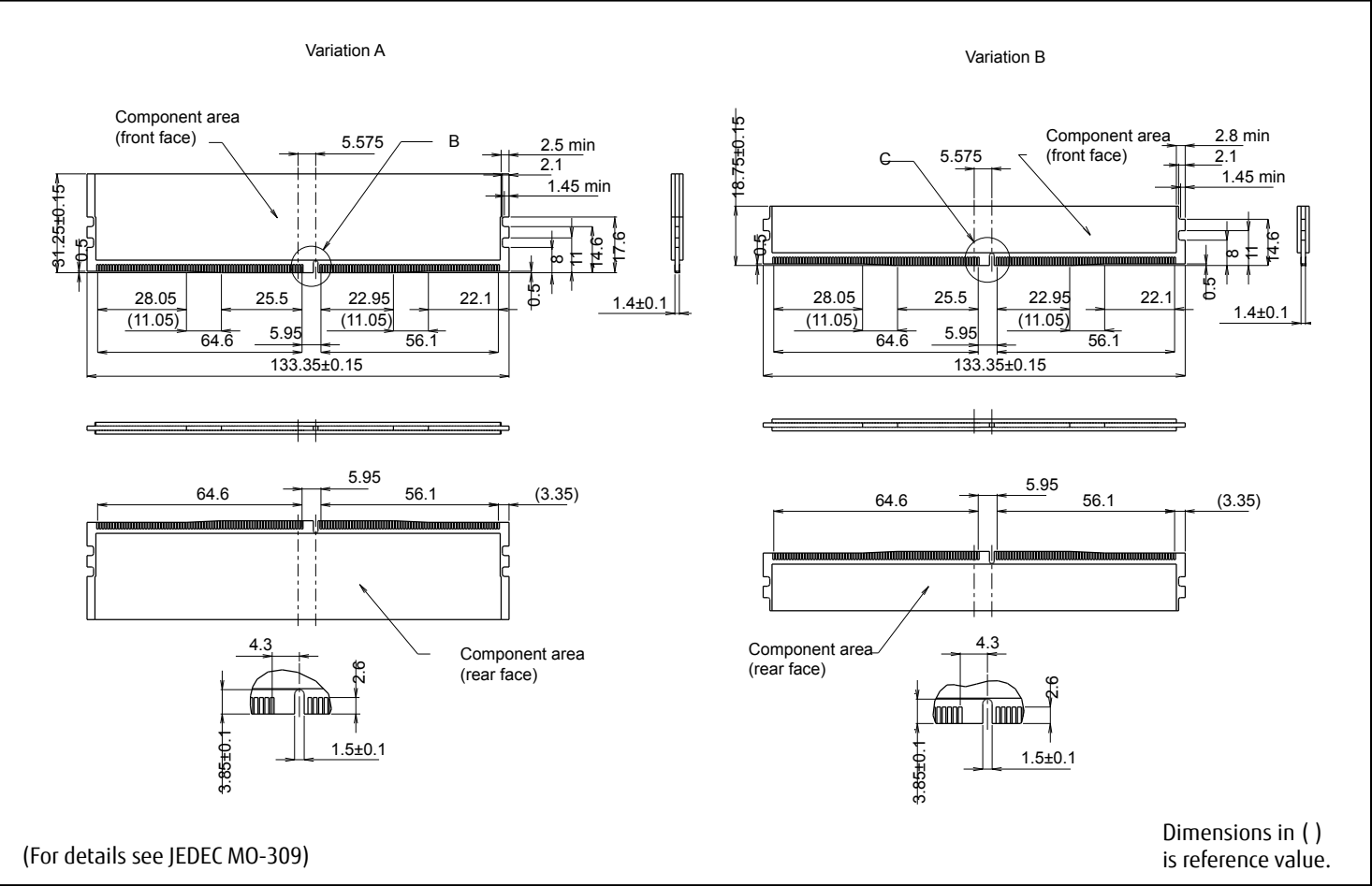
- Recommended printed circuit board pattern (Top view)



■ Recommended soldering conditions (surface mount type)



■ Reference: Recommended memory module terminal shape (applicable to both surface mount/through hole/press fit)



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